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ADDED DIMENSION M AND SOLDERING FOOTPRINT. UPDATED DESCRIPTION. REQ. BY K. KIME.	31 AUG 2005
CHANGED DIMENSION A NOM FROM 0.99 TO 1.00 & MAX FROM 1.20 TO 1.10. REQ. BY L. DELUCA.	29 JUN 2007
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CORRECTED MARKING DIAGRAM TO ADD LOT TRACEABILITY. REQ. BY J. CARTER.	12 APR 2012
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MODIFIED DIMENSIONS D1, D2, E1, & E2. REQ. BY I. MARIANO.	05 MAR 2013
ADDED MIN AND MAX VALUES TO DIMENSIONS D AND E. REQ. BY D. TRUHITTE.	17 JUN 2014
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